

DMTH4007SPDQ 40V 175°C DUAL N-CHANNEL ENHANCEMENT MODE MOSFET

PowerDI5060-8

Product Summary

| BV _{DSS} | Rds(on) Max | I _D Max Tc = +25°C |
|-------------------|-----------------------------|----------------------------------|
| 40V | $8.6m\Omega @ V_{GS} = 10V$ | 48A |

Description and Applications

This MOSFET is designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP and is ideal for use in:

- Backlighting
- Power Management Functions
- DC-DC Converters

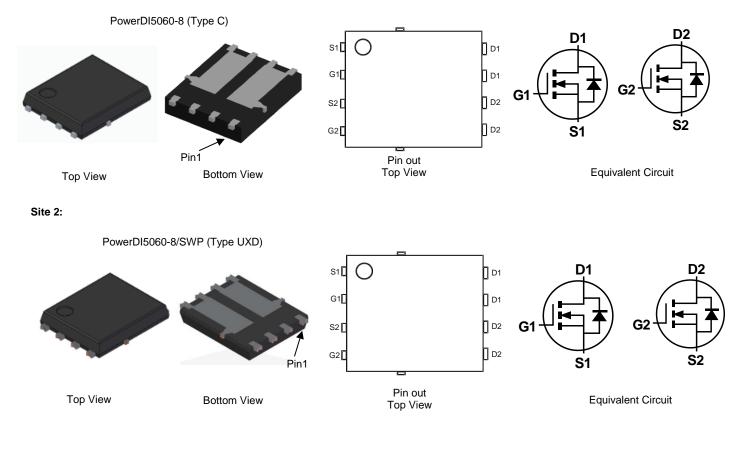
Features and Benefits

- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching (UIS) Test in Production Ensures More Reliable and Robust End Application
- High Conversion Efficiency
- Low R_{DS(ON)} Minimizes On-State Losses
- Low Input Capacitance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMTH4007SPDQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Case: PowerDI[®]5060-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (@)
- Weight: 0.097 grams (Approximate)



PowerDI is a registered trademark of Diodes Incorporated.

Site 1:



Notes:

Ordering Information (Note 4)

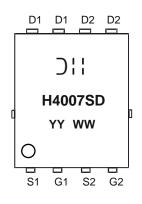
| Part Number | Case | Packaging |
|-----------------|------------------------------|-------------------|
| DMTH4007SPDQ-13 | PowerDI5060-8 (Type C) | 2,500/Tape & Reel |
| DMTH4007SPDQ-13 | PowerDI5060-8/SWP (Type UXD) | 2,500/Tape & Reel |

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and

Lead-free. 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



)'' = Manufacturer's Marking H4007SD <u>=</u> Product Type Marking Code YYWW or YYWW = Date Code Marking YY or \overrightarrow{YY} = Year (ex: 21 = 2021) WW = Week (01 to 53)



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

| Characteristic | | | Symbol | Value | Unit |
|--|--------|-------------------------|--------|-------|------|
| Drain-Source Voltage | | | VDSS | 40 | V |
| Gate-Source Voltage | | | Vgss | ±20 | V |
| Continuous Drain Current (Note 6) Ves = 10V | | $T_C = +25^{\circ}C$ | ID | 48 | A |
| | | $T_{C} = +100^{\circ}C$ | | 34 | |
| Continuous Drain Current (Note 5), VGS = 10V | Steady | T _A = +25°C | ID | 12.5 | А |
| Continuous Drain Current (Note 5), VGS = 10V | State | TA = +100°C | | 9.0 | ~ |
| Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%) | | Idм | 192 | A | |
| Maximum Continuous Body Diode Forward Current (Note 6) | | | ls | 34 | A |
| Avalanche Current, L = 0.1mH | | | las | 20 | A |
| Avalanche Energy, L = 0.1mH | | | Eas | 20 | mJ |

Thermal Characteristics

| Characteristic | | Symbol | Value | Unit |
|--|------------------------|----------|-------------|------|
| Total Power Dissipation (Note 5) | T _A = +25°C | PD | 2.6 | W |
| Thermal Resistance, Junction to Ambient (Note 5) | Steady State | Reja | 57 | °C/W |
| Total Power Dissipation (Note 6) | Tc = +25°C | PD | 37.5 | W |
| Thermal Resistance, Junction to Case (Note 6) | | Rejc | 4 | °C/W |
| Operating and Storage Temperature Range | | TJ, TSTG | -55 to +175 | °C |

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Min | Тур | Max | Unit | Test Condition | |
|------------------------------------|---------------------|-----|-------|------|------|--|--|
| OFF CHARACTERISTICS (Note 7) | _ | | | | | | |
| Drain-Source Breakdown Voltage | BVDSS | 40 | — | | V | $V_{GS} = 0V, I_D = 1mA$ | |
| Zero Gate Voltage Drain Current | IDSS | _ | _ | 1 | μA | V _{DS} = 32V, V _{GS} = 0V | |
| Gate-Source Leakage | Igss | _ | — | ±100 | nA | $V_{GS} = \pm 20V, V_{DS} = 0V$ | |
| ON CHARACTERISTICS (Note 7) | | | | | | - | |
| Gate Threshold Voltage | VGS(TH) | 2 | _ | 4 | V | $V_{DS} = V_{GS}, I_D = 250 \mu A$ | |
| Static Drain-Source On-Resistance | Rds(on) | _ | 7.5 | 8.6 | mΩ | Vgs = 10V, ID = 17A | |
| Diode Forward Voltage | V _{SD} | | 0.85 | 1.2 | V | $V_{GS} = 0V, I_{S} = 17A$ | |
| DYNAMIC CHARACTERISTICS (Note 8) | | | | | | | |
| Input Capacitance | Ciss | | 2,026 | _ | pF | | |
| Output Capacitance | Coss | | 702 | — | pF | − V _{DS} = 30V, V _{GS} = 0V, − f = 1MHz | |
| Reverse Transfer Capacitance | C _{rss} | _ | 84.8 | _ | pF | | |
| Gate Resistance | Rg | — | 0.46 | — | Ω | $V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$ | |
| Total Gate Charge | QG | _ | 41.9 | — | nC | | |
| Gate-Source Charge | Qgs | _ | 10 | — | nC | $V_{DS} = 30V, I_D = 20A, V_{GS} = 10V$ | |
| Gate-Drain Charge | Q _{GD} | | 11.5 | _ | nC | | |
| Turn-On Delay Time | tD(ON) | | 7 | — | ns | | |
| Turn-On Rise Time | tR | _ | 11.5 | _ | ns | V _{DD} = 30V, V _{GS} = 10V, I _D = 20A, R _G = 3Ω | |
| Turn-Off Delay Time | t _{D(OFF)} | | 15.6 | | ns | | |
| Turn-Off Fall Time | tF | _ | 8.8 | | ns | 7 | |
| Body Diode Reverse Recovery Time | trr | _ | 29.9 | | ns | | |
| Body Diode Reverse Recovery Charge | Q _{RR} | | 23 | | nC | − I _F = 20A, di/dt = 100A/μs | |

Notes: 5. Device mounted on FR-4 substrate PC board, 2oz. copper, with thermal bias to bottom layer 1inch square copper plate.

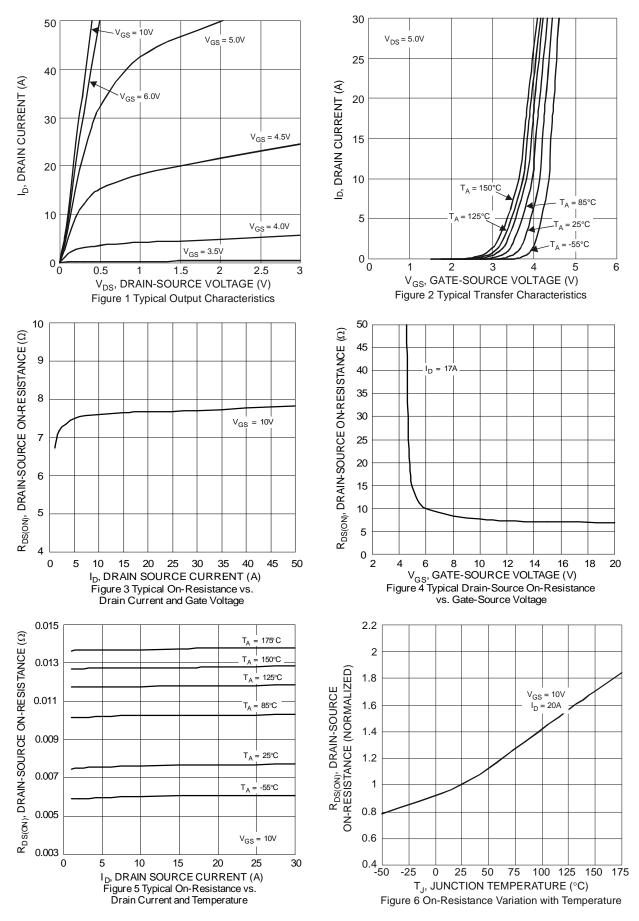
6. Thermal resistance from junction to soldering point (on the exposed drain pad).

7. Short duration pulse test used to minimize self-heating effect.

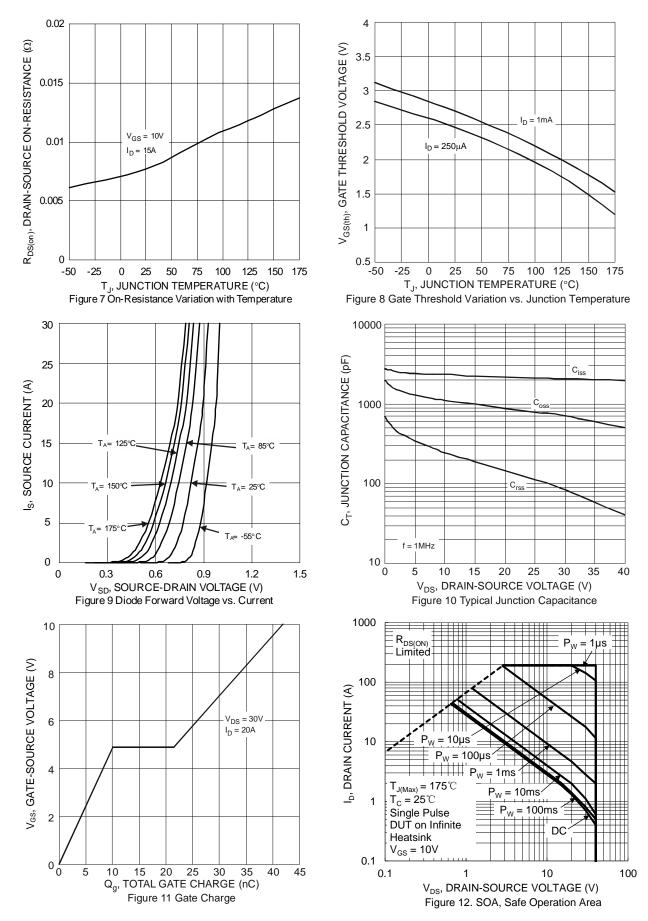
8. Guaranteed by design. Not subject to product testing.



DMTH4007SPDQ

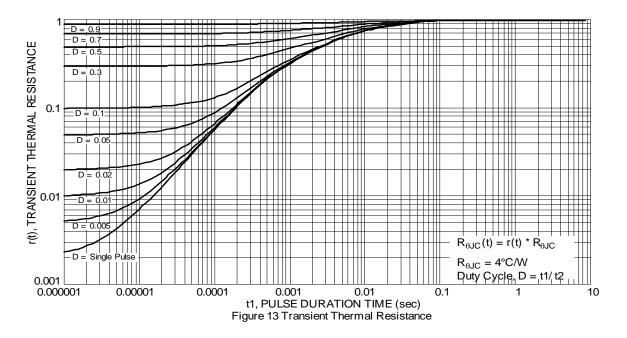






DMTH4007SPDQ Document number: DS38393 Rev. 2 - 2



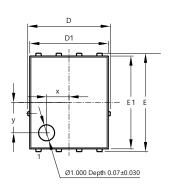


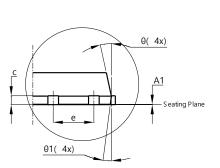


Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

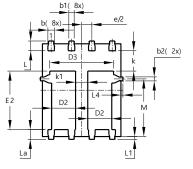
Site 1:

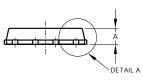




PowerDI5060-8 (Type C)

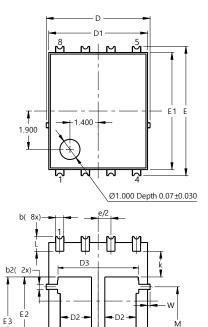
DETAIL A





| Pow | PowerDI5060-8 (Type C) | | | | |
|-----|------------------------|---------|-------|--|--|
| Dim | Min | Max | Тур | | |
| Α | 0.90 | 1.10 | 1.00 | | |
| A1 | 0 | 0.05 | 0.02 | | |
| b | 0.33 | 0.51 | 0.41 | | |
| b1 | 0.300 | 0.366 | 0.333 | | |
| b2 | 0.20 | 0.35 | 0.25 | | |
| С | 0.23 | 0.33 | 0.277 | | |
| D | 5 | .15 BS0 | 2 | | |
| D1 | 4.85 | 4.95 | 4.90 | | |
| D2 | 1.40 | 1.60 | 1.50 | | |
| D3 | - | - | 3.98 | | |
| Е | 6 | .15 BS0 | 2 | | |
| E1 | 5.75 | 5.85 | 5.80 | | |
| E2 | 3.56 | 3.76 | 3.66 | | |
| е | 1 | .27BSC | | | |
| k | - | - | 1.27 | | |
| k1 | 0.56 | - | - | | |
| L | 0.51 | 0.71 | 0.61 | | |
| La | 0.51 | 0.71 | 0.61 | | |
| L1 | 0.05 | 0.20 | 0.175 | | |
| L4 | - | - | 0.125 | | |
| М | 3.50 | 3.71 | 3.605 | | |
| х | - | - | 1.400 | | |
| У | - | - | 1.900 | | |
| θ | 10° | 12° | 11° | | |
| θ1 | 6° | 8° | 7° | | |
| All | All Dimensions in mm | | | | |

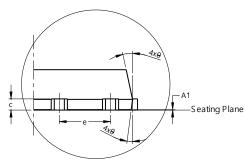
Site 2:



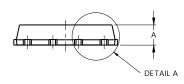
L_{L1}

-b4(8x)

PowerDI5060-8/SWP (Type UXD)



DE TAIL A



| Po | PowerDI5060-8/SWP (Type UXD) | | | | |
|-----|---------------------------------|---------|-------|--|--|
| Dim | Min | Max | Тур | | |
| Α | 0.90 | 1.10 | 1.00 | | |
| A1 | 0.00 | 0.05 | | | |
| b | 0.30 | 0.50 | 0.41 | | |
| b2 | 0.20 | 0.35 | 0.25 | | |
| b4 | (|).25REF | - | | |
| С | 0.230 | 0.330 | 0.277 | | |
| D | 5 | .15 BS0 | 0 | | |
| D1 | 4.70 | 5.10 | 4.90 | | |
| D2 | 1.46 | 1.66 | 1.55 | | |
| D3 | 3.78 | 4.18 | 3.98 | | |
| E | 6 | .40 BS0 | 0 | | |
| E1 | 5.60 | 6.00 | 5.80 | | |
| E2 | 3.46 | 3.86 | 3.66 | | |
| E2a | 4.195 | 4.595 | 4.395 | | |
| е | 1 | .27BSC | ~ | | |
| k | 1.05 | | - | | |
| L | 0.635 | 0.835 | 0.735 | | |
| La | 0.635 | 0.835 | 0.735 | | |
| L1 | 0.200 | 0.400 | 0.300 | | |
| М | 3.205 | 4.005 | 3.605 | | |
| W | 0.025 | 0.225 | 0.125 | | |
| θ | 10° | 12° | 11° | | |
| θ1 | 6° | 8° | 7° | | |
| All | All Dimensions in mm | | | | |

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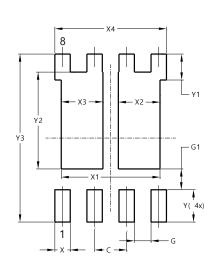


Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

Site 1:

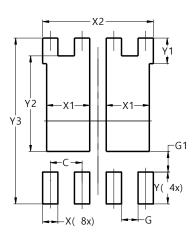
PowerDI5060-8 (Type C)



| Dimensions | Value (in mm) | | |
|------------|------------------|--|--|
| | | | |
| С | 1.270 | | |
| G | 0.660 | | |
| G1 | 0.820 | | |
| Х | 0.610 | | |
| X1 | 3.910 | | |
| X2 | 1.650 | | |
| X3 | 1.650 | | |
| X4 | 4.420 | | |
| Y | 1.270 | | |
| Y1 | 1.020 | | |
| Y2 | 3.810 | | |
| Y3 | 6.610 | | |

Site 2:

PowerDI5060-8/SWP (Type UXD)



| Dimensions | Value | |
|------------|---------|--|
| Dimensions | (in mm) | |
| С | 1.270 | |
| G | 0.660 | |
| G1 | 0.820 | |
| Х | 0.610 | |
| X1 | 1.720 | |
| X2 | 4.420 | |
| Y | 1.270 | |
| Y1 | 1.020 | |
| Y2 | 3.810 | |
| Y3 | 6.610 | |



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